

PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCN No.	ANALOG MEMS SENSORS/25/15599	
1.3 Title of PCN	ST Manufacturing Reshaping (Analog_Adv BCD9 BSM/BCD110_AG200toSG8_All): Qualification of SG8 (Singapore) as new FE Location.	
1.4 Product Category	Please refer to the impacted Products List in BCD9 BSM / BCD110.	
1.5 Issue date	2025-07-29	

2. PCN Team

2.1 Contact supplier	
2.1.1 Name	PIKE EMMA
2.1.2 Phone	+44 1628896111
2.1.3 Email	emma.pike@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Domenico ARRIGO, Marcello SAN BIAGIO
2.1.2 Marketing Manager	Fabio CHELLI, Elena Maria PERNIGOTTI, Vito GRAZIANO, Salvatore DI VINCENZO, Fabio LORITO
2.1.3 Quality Manager	Alessandro PLATINI, Alberto BIGNAZZI, Daniela FAZIO, Paolo MORETTI

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Manufacturing reshaping program	Manufacturing reshaping program	SG8 (Singapore)

4. Description of change

	Old	New
4.1 Description	AG200 (Italy) as FE Plant	SG8 (Singapore) as FE Plant
4.2 Anticipated Impact on form, fit, function, quality, reliability or processability?	No Impact. The products guarantee the same quality and electrical characteristics as per current production.	

5. Reason / motivation for change

5.1 Motivation	In the frame of ST manufacturing reshaping program (refer to Corporate PCI 15383 - Early Notification), following the continuous improvement of our service and to increase production Capacity, ST Microelectronics is announcing the qualification of SG8 (Singapore) as FE Location for the impacted Products in BCD9 BSM / BCD110 Technology. Please be advised that the enclosed list of products and dates could be subject to change. Such modifications may occur as part of the ongoing transformation program and will be communicated as and when available. ST will explore the scale up of this technology perimeter and products into 300mm (12") in the future in AG factory. Any timeline and specific communication would be done in future with customers.
5.2 Customer Benefit	SERVICE CONTINUITY

6. Marking of parts / traceability of change

6.1 Description	Traceability of change will be ensured by an internal codification (Finished Good/Type) printed on the carton box label.
-----------------	--

7. Timing / schedule

7.1 Date of qualification results	2026-07-15
7.2 Intended start of delivery	2027-01-15
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation

8.1 Description			
8.2 Qualification report and qualification results	In progress	Issue Date	

9. Attachments (additional documentations)		
15599 Public product.pdf 15599 Qualification Plan Detail_adv BCD9 BSM - BCD110.pdf		

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	L978S-TR	
	STSPIN948	
	STSPIN948TR	
	STSPIN958	
	STSPIN958TR	
	L9001-TR	

IMPORTANT NOTICE – PLEASE READ CAREFULLY

Subject to any contractual arrangement in force with you or to any industry standard implemented by us, STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.